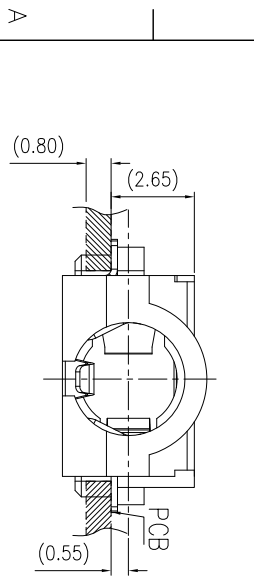
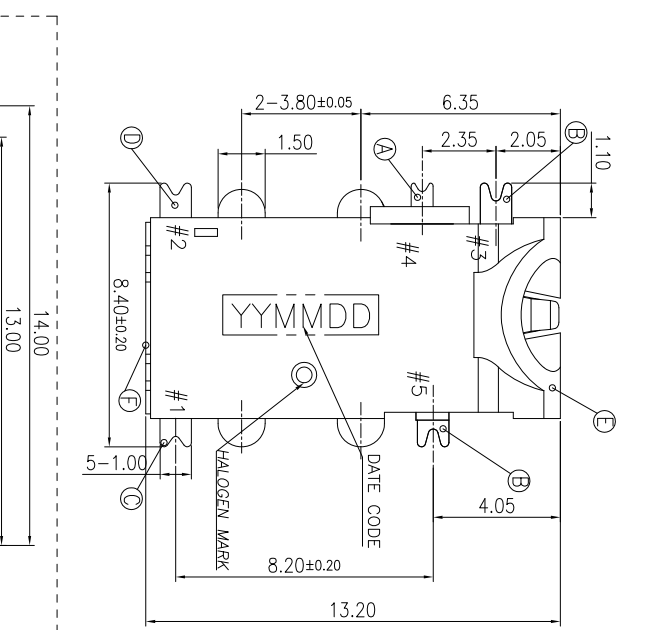
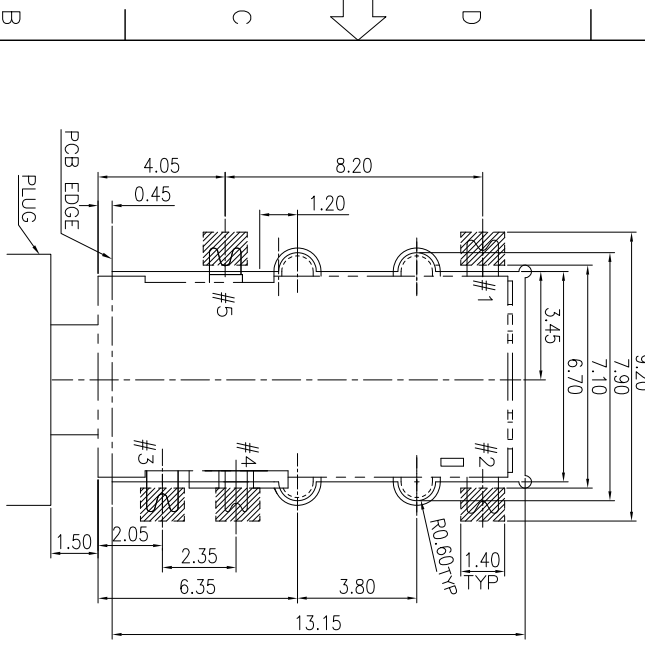


- SPECIFICATIONS:**
- ELECTRICAL CHARACTERISTICS:
 - RATING : 12V /1A
 - CONTACT RESISTANCE: 30mMAX(INITIAL).
 - MECHANICAL CHARACTERISTICS:
 - INSERTION FORCE : 0.3~3.0 KGF
 - WITHDRAWAL FORCE : 0.3~3.0 KGF
 - LIFE TEST: 5,000 CYCLES .
 - TO CONFORM TO THE SINGATRON HSF SPECIFICATION.
 - HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT.
 - HALOGEN PRODUCT IDENTIFICATION LABEL ON PACKAGING.
 - FOR REFLOW SOLDERING LEAD-FREE PROCESS.
 - FOR SOLDER HEAT RESISTANCE REFLOW SOLDERING 260°C 10SECS.
 - PACKAGING: TAPE & REEL.



NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
F	COVER	1	SUS	N/A
E	BODY	1	HI-TEMP THERMOPLASTIC UL94V-0	BLACK
D	RING SPRING A	1	COPPER ALLOY 0.2t	GOLD FLASH
C	TIP SPRING	1	COPPER ALLOY 0.2t	Gold flash on contact area And solder tail, all over Nickel plated
B	RING SPRING B	2	COPPER ALLOY 0.2t	GOLD FLASH
A	EARTH	1	COPPER ALLOY 0.2t	GOLD FLASH
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES

Singatron Enterprise Co., Ltd.
信亨企業股份有限公司

DECIMALS: ANGLES:

X : ±0.5 X : ±2°
X.X : ±0.3 X.X : ±1°
X.XX : ±0.2

TITLE: 3.5Ø PHONE JACK

PART NO. 2S12317-001111

SCALE 5:1 UNIT: mm

SIZE: A3 SHEET: 10F1 REV: B

REV.	ECN NO. OR DESCRIPTION	REVISED	DATE
A	PRODUCTS RELEASE	ARES	2010.11.18
B	ECR:C110387 Modify plating	LONGLIANG	2012.01.03